INTERNATIONAL STANDARD

ISO/IEC 8885

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Information technology — Telecommunications and information exchange between systems — High-level data link control (HDLC) procedures — General purpose XID frame information field content and format

AMENDMENT 9: Extension of HDLC sequence number modulus beyond 128

Technologies de l'information — Télécommunications et échange d'informations entre systèmes — Procédures de commande de liaison de données à haut niveau (HDLC) — Format et contenu du champ d'information de la trame XID pour application générale

AMENDEMENT 9: Extension du module du numéro de séquence HDLC au-delà de 128



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Foreword

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Amendment 9 to International Standard ISO/IEC 8885:1993 was prepared by Joint Technical Committee ISO/IEC JTC 1, Information technology, Subcommittee SC 6, Telecommunications and information exchange between systems.

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